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Vishay General Semiconductor

# Surface Mount Trench MOS Barrier Schottky Rectifiers



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### DESIGN SUPPORT TOOLS



PRIMARY CHARACTERISTICS							
I <sub>F(AV)</sub>	3.0 A						
V <sub>RRM</sub>	45 V						
I <sub>FSM</sub>	50 A						
$V_F$ at $I_F$ = 2 A ( $T_A$ = 125 °C)	0.43 V						
T <sub>J</sub> max.	150 °C						
Package	SMF (DO-219AB)						
Circuit configuration	Single						

### FEATURES

- Trench MOS Schottky technology
- Low profile package
- Ideal for automated placement
- Low forward voltage drop, low power losses
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
  Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

## **MECHANICAL DATA**

**Case:** SMF (DO-219AB) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	V3FL45	UNIT				
Device marking code		3LE					
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	45	V				
Maximum average forward restified surrent (fig 1)	I <sub>F(AV)</sub> <sup>(1)</sup>	2.5	٨				
Maximum average forward rectified current (fig.1)	I <sub>F(AV)</sub> <sup>(2)</sup>	3.0	A				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50	А				
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +150	<b>0°</b>				
Storage temperature range	T <sub>STG</sub>	-55 to +150	U				

#### Notes

<sup>(2)</sup> Mounted on FR4 PCB, 2 oz.10 mm x 10 mm copper pad area

 $^{(3)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient: dP<sub>D</sub>/dT<sub>J</sub> < 1/R<sub>0JA</sub>

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RoHS

COMPLIANT

HALOGEN

FREE

<sup>&</sup>lt;sup>(1)</sup> Free air, mounted on FR4 PCB, 2 oz. standard footprint

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## **V3FL45**



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)								
PARAMETER	TEST C	ONDITIONS	SYMBOL	TYP.	MAX.	UNIT		
Instantaneous forward voltage	I <sub>F</sub> = 1.5 A	T <sub>A</sub> = 25 °C		0.44	-	v		
	I <sub>F</sub> = 3.0 A	$I_{A} = 25$ C	V <sub>E</sub> (1)	0.50	0.58			
	I <sub>F</sub> = 1.5 A	T <sub>A</sub> = 125 °C	VF()	0.34	-			
	I <sub>F</sub> = 3.0 A			0.43	0.51			
Reverse current		T <sub>A</sub> = 25 °C	L (2)	-	0.75	0		
	V <sub>R</sub> = 45 V	T <sub>A</sub> = 125 °C	– I <sub>R</sub> <sup>(2)</sup> –	4	15	mA		
Typical junction capacitance	4.0 V, 1 MHz	+	CJ	370	-	pF		

Notes

<sup>(1)</sup> Pulse test: 300 µs pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25$ °c unless otherwise noted)							
PARAMETER	SYMBOL	V3FL45	UNIT				
Typical thermal resistance	R <sub>0JA</sub> (1)(2)	125	°C/W				
Typical therman resistance	R <sub>0JM</sub> <sup>(3)</sup>	18	0/ 00				

#### Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

<sup>(2)</sup> Device mounted on FR4 PCB, 2 oz. standard footprint, thermal resistance  $R_{\theta JA}$  – junction-to-ambient

<sup>(3)</sup> Device mounted on 10 mm x 10 mm pad size area footprint; thermal resistance  $R_{\theta JM}$  – junction-to-mount

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
V3FL45-M3/H	0.015	Н	3000	7" diameter plastic tape and reel				
V3FL45-M3/I	0.015	I	10 000	13" diameter plastic tape and reel				
V3FL45HM3/H <sup>(1)</sup>	0.015	н	3000	7" diameter plastic tape and reel				
V3FL45HM3/I <sup>(1)</sup>	0.015	I	10 000	13" diameter plastic tape and reel				

Note

(1) AEC-Q101 qualified



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## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)

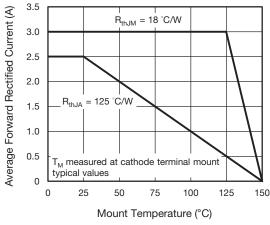
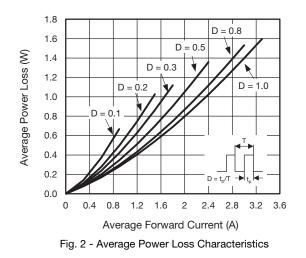
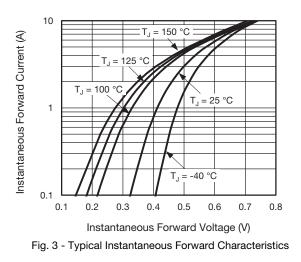
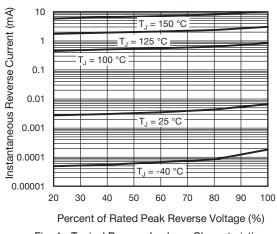
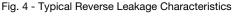


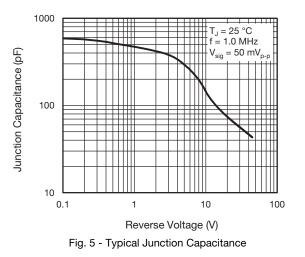
Fig. 1 - Maximum Forward Current Derating Curve











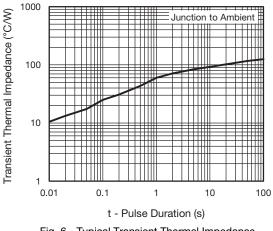


Fig. 6 - Typical Transient Thermal Impedance

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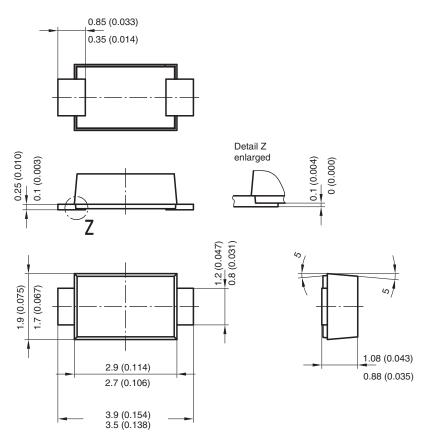
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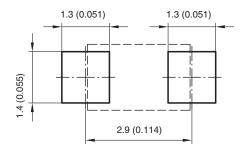


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### **PACKAGE OUTLINE DIMENSIONS** in millimeters (inches)



Foot print recommendation:

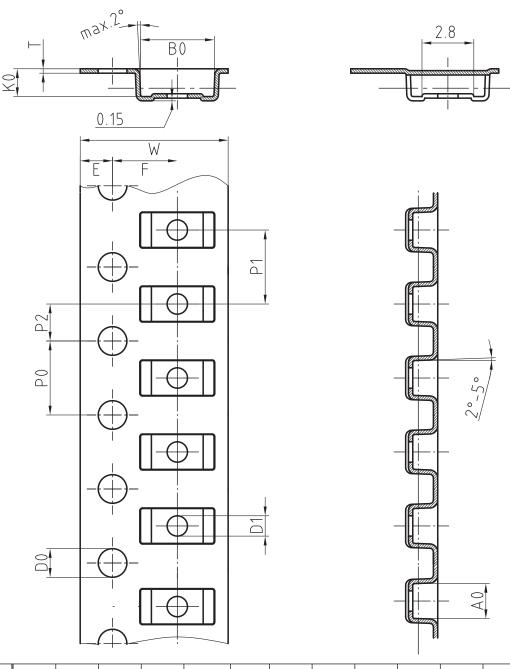


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## BLISTERTAPE DIMENSIONS in millimeters: SMF (DO-219AB)



Mat:	Α0	B0	K0	W	Т	P0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

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